

50 V, 2.7 A PNP/PNP low V_{CEsat} (BISS) transistor Rev. 01 — 3 April 2007 Pro

Product data sheet

Product profile 1.

1.1 General description

PNP/PNP double low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a medium power Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package N		NPN/PNP	NPN/NPN	
	Nexperia	Name	complement	complement	
PBSS5350SS	SOT96-1	SO8	PBSS4350SPN	PBSS4350SS	

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FF}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- Dual low power switches (e.g. motors, fans)
- Automotive

1.4 Quick reference data

Table 2. Quick reference data

Parameter	Conditions	Min	Тур	Max	Unit
sistor					
collector-emitter voltage	open base	-	-	-50	V
collector current		-	-	-2.7	А
peak collector current	single pulse; t _p ≤ 1 ms	-	-	-5	A
collector-emitter saturation resistance	I _C = -2 A; I _B = -200 mA	<u>[1]</u> -	95	140	mΩ
	collector-emitter voltage collector current peak collector current collector-emitter	sistorcollector-emitter voltageopen basecollector currentsingle pulse; $t_p \le 1 \text{ ms}$ collector-emitterI_C = -2 A;	sistorcollector-emitter voltageopen base-collector current-peak collector currentsingle pulse; $t_p \le 1 \text{ ms}$ -collector-emitter $I_C = -2 \text{ A};$ [1]	sistorcollector-emitter voltageopen base-collector currentpeak collector currentsingle pulse; $t_p \le 1 \text{ ms}$ -collector-emitterI_C = -2 A;[1] -95	sistercollector-emitter voltageopen base50collector current2.7peak collector currentsingle pulse; $t_p \le 1 \text{ ms}$ 5collector-emitter $I_C = -2 \text{ A};$ [1] -95140

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

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2. Pinning information

Table 3.	Pinning		
Pin	Description	Simplified outline	Symbol
1	emitter TR1		
2	base TR1		
3	emitter TR2		
4	base TR2		
5	collector TR2		1 2 3 4
6	collector TR2		<i>006aaa976</i>
7	collector TR1		
8	collector TR1		

3. Ordering information

Table 4. Orde	ring informa	ation		
Type number	Package			
	Name	Description	Version	
PBSS5350SS	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1	

4. Marking

Table 5. Marking codes	
Type number	Marking code
PBSS5350SS	5350SS

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transist	tor				
V _{CBO}	collector-base voltage	open emitter	-	-50	V
V _{CEO}	collector-emitter voltage	open base	-	-50	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current		-	-2.7	А
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-5	A
I _B	base current		-	-0.5	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.55	W
			[2] _	0.87	W
			[3] _	1.43	W

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Symbol	Parameter	Conditions	Min	Max	Unit
Per device					
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	0.75	W
		[2] _	1.2	W	
			[3] _	2	W
Тj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

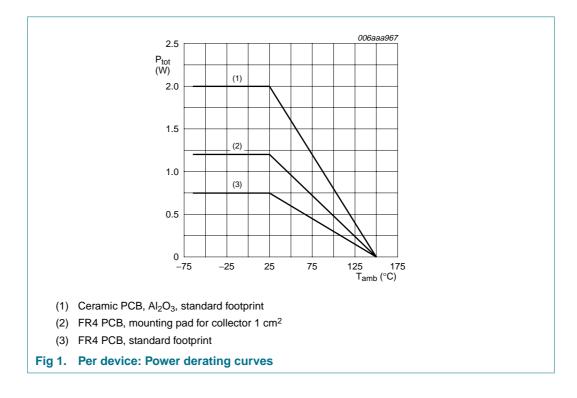
 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



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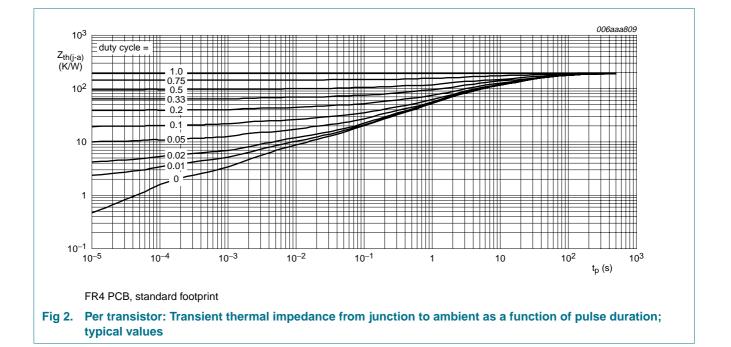
6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
· · ແ (()-a)	thermal resistance from		<u>[1]</u> _	-	227	K/W
	junction to ambient		[2] _	-	144	K/W
			[3]	-	87	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	40	K/W
Per devic	e					
R _{th(j-a)} thermal resistance from junction to ambient	-a) thermal resistance from in free air	in free air	<u>[1]</u> _	-	167	K/W
	junction to ambient		[2] _	-	104	K/W
			[3] _	-	63	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

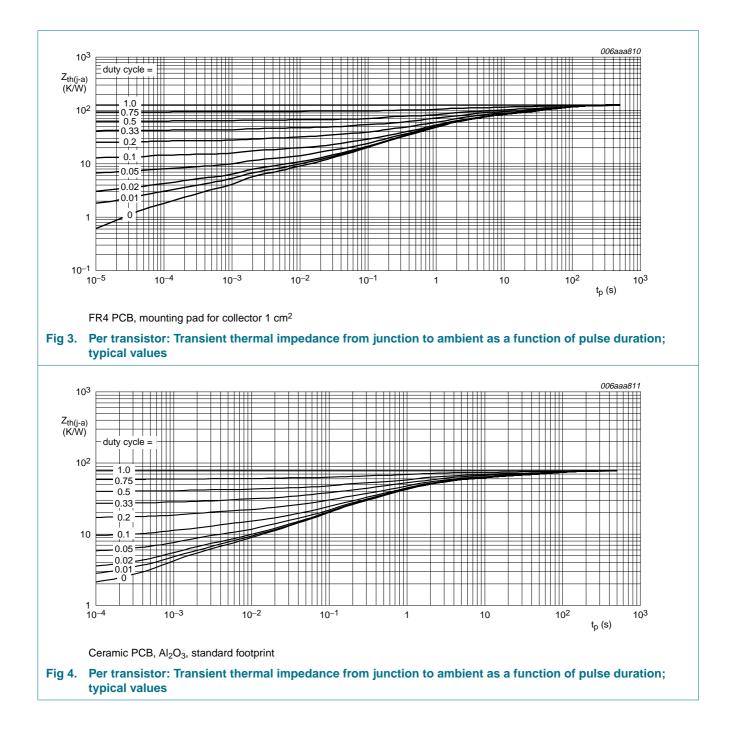
[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.



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7. Characteristics

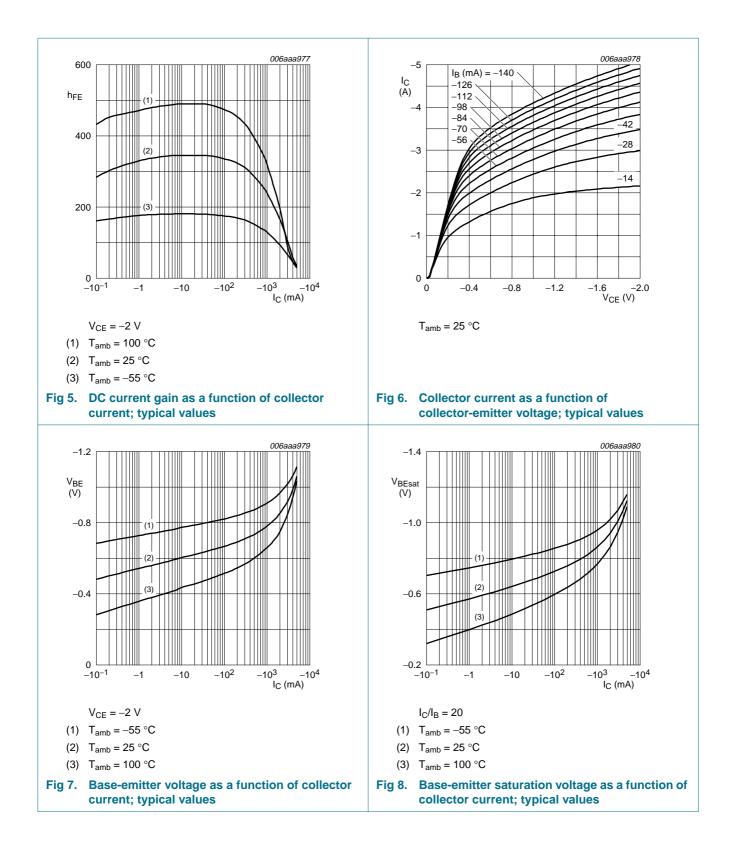
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per trans	sistor						
I _{CBO}		$V_{CB} = -50$ V; $I_E = 0$ A		-	-	-100	nA
	current	$\label{eq:VCB} \begin{split} V_{CB} &= -50 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \\ T_{j} &= 150 ^{\circ}\text{C} \end{split}$		-	-	-50	μA
I _{CES}	collector-emitter cut-off current	$V_{CE} = -50 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 V; I_C = 0 A$		-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$		200	340	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	[1]	200	290	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	[1]	180	250	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$	[1]	130	180	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2.7 \text{ A}$	[1]	95	135	-	
V _{CEsat} collector-emitter			[1]				
	saturation voltage	$I_{C} = -0.5 \text{ A}; I_{B} = -50 \text{ mA}$		-	-60	-90	mV
		$I_{C} = -1 \text{ A}; I_{B} = -50 \text{ mA}$		-	-125	-180	mV
	$I_{C} = -2 \text{ A}; I_{B} = -100 \text{ mA}$		-	-225	-320	mV	
		$I_{C} = -2 \text{ A}; I_{B} = -200 \text{ mA}$		-	-190	-280	mV
		$I_{C} = -2.7 \text{ A}; I_{B} = -270 \text{ mA}$		-	-255	-370	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{\rm C} = -2$ A; $I_{\rm B} = -200$ mA	<u>[1]</u>	-	95	140	mΩ
V _{BEsat}	base-emitter		[1]				
	saturation voltage	$I_{C} = -2 \text{ A}; I_{B} = -100 \text{ mA}$		-	-0.95	-1.1	V
		$I_{C} = -2.7 \text{ A}; I_{B} = -270 \text{ mA}$		-	-1	-1.2	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 V; I_C = -1 A$	<u>[1]</u>	-	-0.8	-1.2	V
t _d	delay time	$V_{CC} = -10 \text{ V}; I_C = -2 \text{ A};$		-	9	-	ns
t _r	rise time	I _{Bon} = −100 mA; I _{Boff} = 100 mA		-	54	-	ns
t _{on}	turn-on time			-	63	-	ns
t _s	storage time			-	190	-	ns
t _f	fall time			-	50	-	ns
t _{off}	turn-off time			-	240	-	ns
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_E = \text{i}_e = 0 \text{ A};$ f = 1 MHz		-	25	35	pF

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

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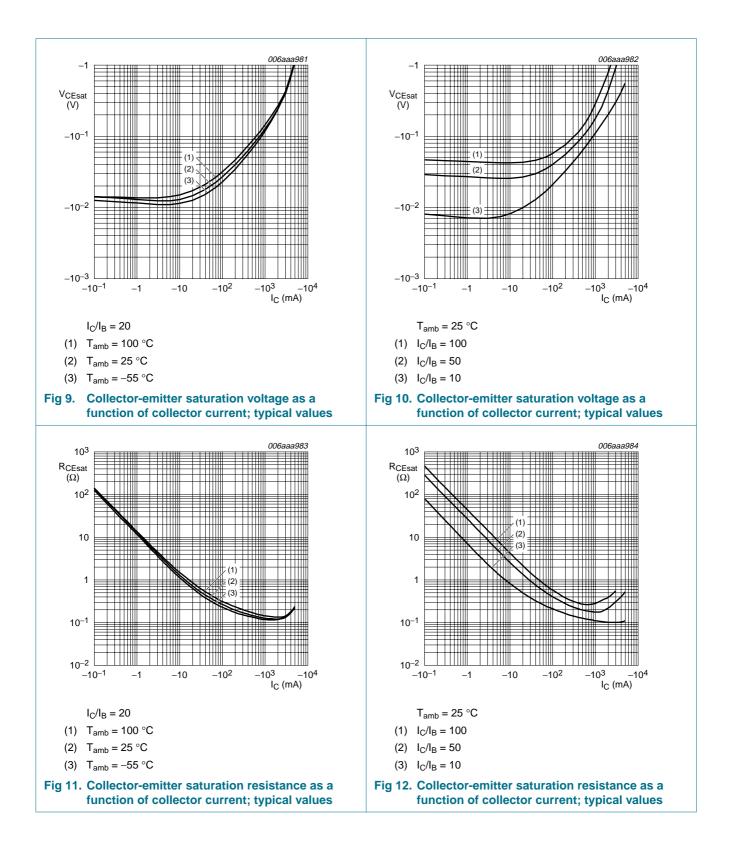


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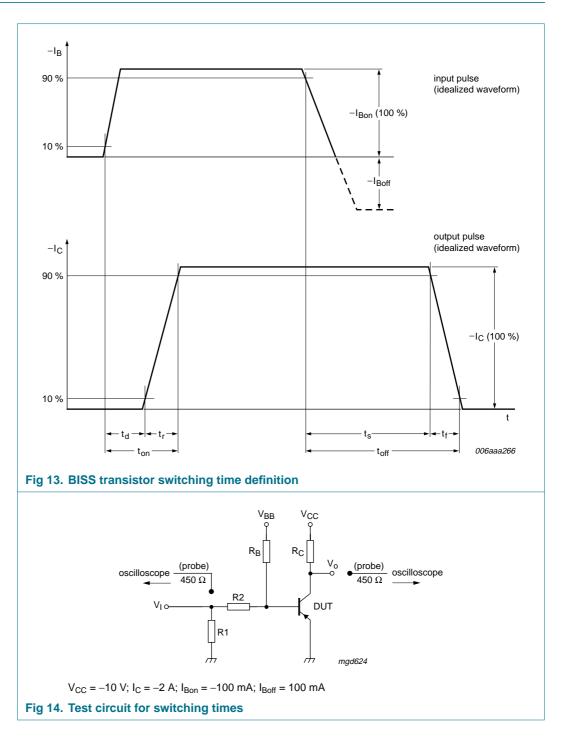
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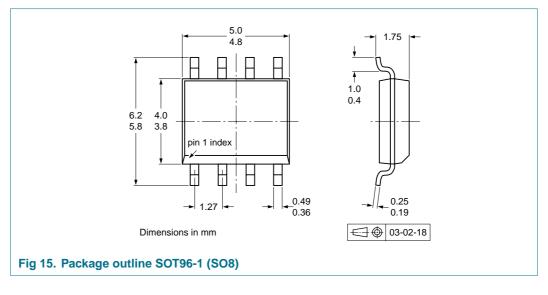
50 V, 2.7 A PNP/PNP low V_{CEsat} (BISS) transistor

8. Test information



50 V, 2.7 A PNP/PNP low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 9. Packing methods

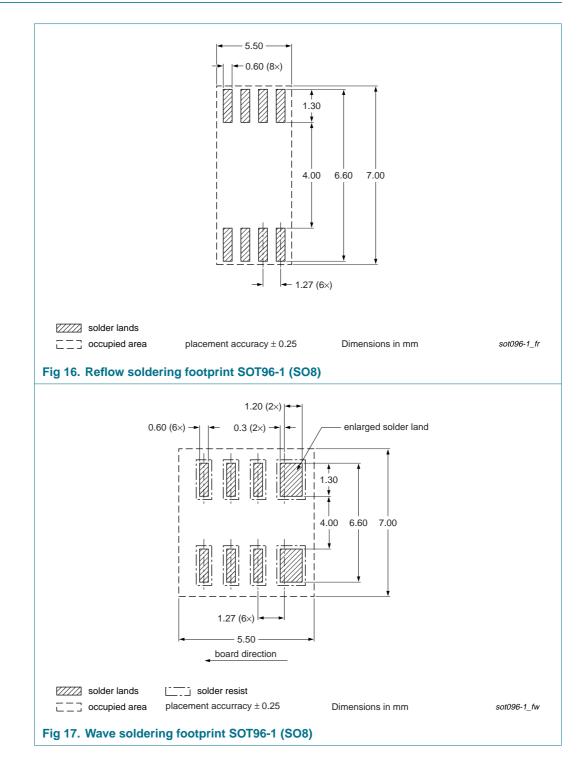
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package Description		Packing	g quantity
			1000	2500
PBSS5350SS	SOT96-1	8 mm pitch, 12 mm tape and reel	-115	-118

[1] For further information and the availability of packing methods, see Section 14.

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11. Soldering



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12. Revision history

Table 10. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS5350SS_1	20070403	Product data sheet	-	-

PBSS5350SS_1

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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